



JW

Docket No.:

M1071.1887
(Patent)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

HAMANAKA, KENICHI

Application Number: 10/735,891

Confirmation No.: 5697

Application Date: December 16, 2003

Art Unit: n/a

For: ADHESIVE RESIN COMPOSITION AND METHOD
OF PRODUCING THE SAME, AND CHIP COIL
COMPONENT

Examiner: Unassigned

STATUS INQUIRY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir,

It is respectfully requested that the attorney named below be advised of the status of the above-identified application. Please advise us of when we might expect to receive an Office Action from the Patent and Trademark Office.

Respectfully Submitted,

Edward A. Meilman

Registration Number: 24,735

DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP
1177 Avenue of the Americas • New York, NY 10036-2714
Tel (212) 835-1400 • Fax (212) 997-9880
Attorney for Applicant

Dated: October 19, 2005